



VEC2415

N-Channel Power MOSFET 60V, 3A, 80mΩ, Dual VEC8

ON Semiconductor®

<http://onsemi.com>

Features

- Low ON-resistance
- Composite type facilitating high-density mounting
- 4V drive
- Mounting high 0.75mm
- Protection diode in

Specifications

Absolute Maximum Ratings at Ta=25°C

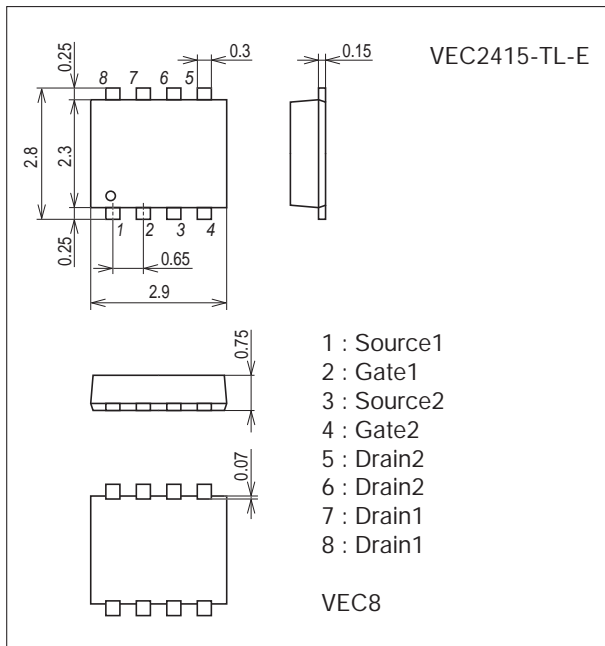
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		60	V
Gate-to-Source Voltage	V _{GSS}		±20	V
Drain Current (DC)	I _D		3	A
Drain Current (Pulse)	I _{DP}	PW≤10μs, duty cycle≤1%	12	A
Allowable Power Dissipation	P _D	When mounted on ceramic substrate (900mm ² ×0.8mm) 1unit	0.9	W
Total Dissipation	P _T	When mounted on ceramic substrate (900mm ² ×0.8mm)	1.0	W
Channel Temperature	T _{ch}		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Package Dimensions

unit : mm (typ)

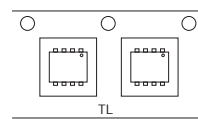
7012-002



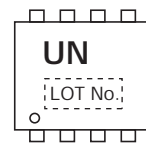
Product & Package Information

- Package : VEC8
- JEITA, JEDEC : -
- Minimum Packing Quantity : 3,000 pcs./reel

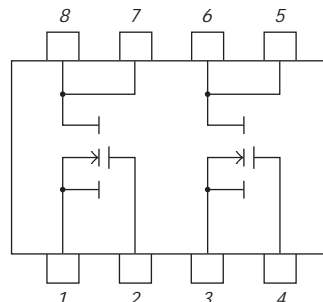
Packing Type : TL



Marking



Electrical Connection

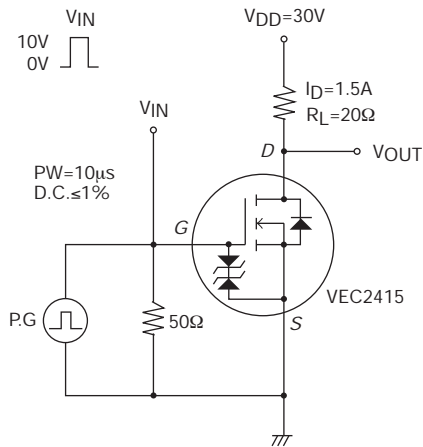


VEC2415

Electrical Characteristics at Ta=25°C

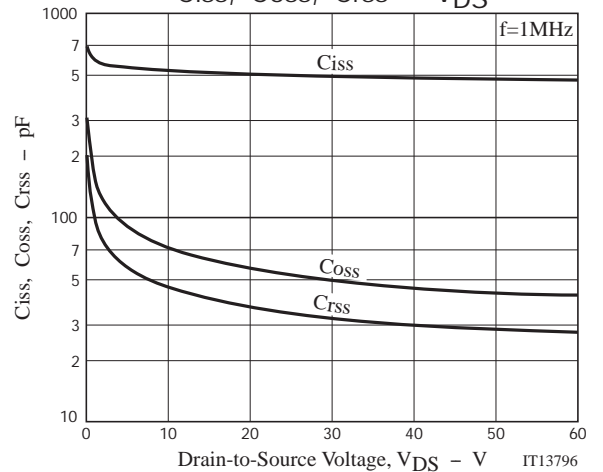
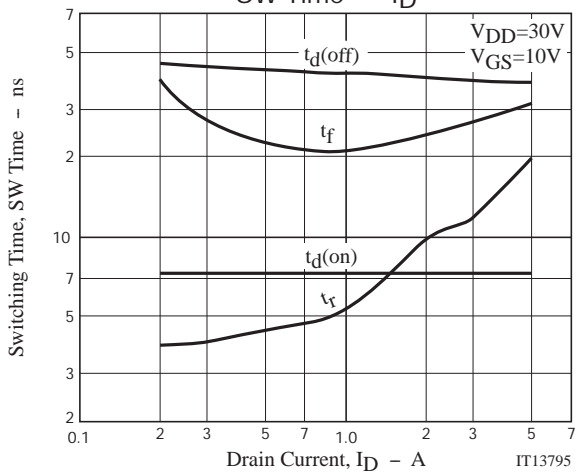
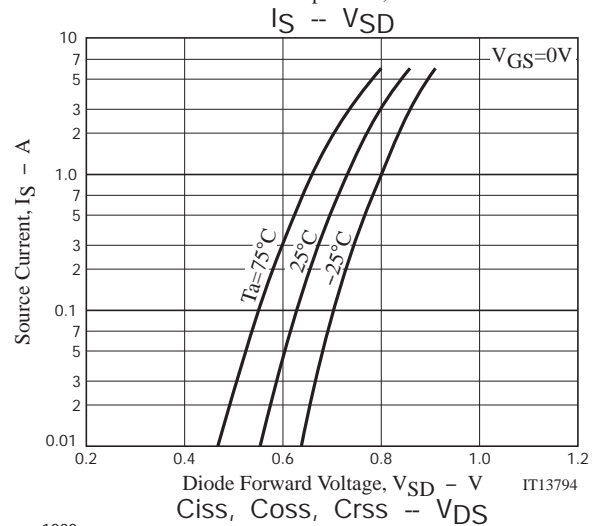
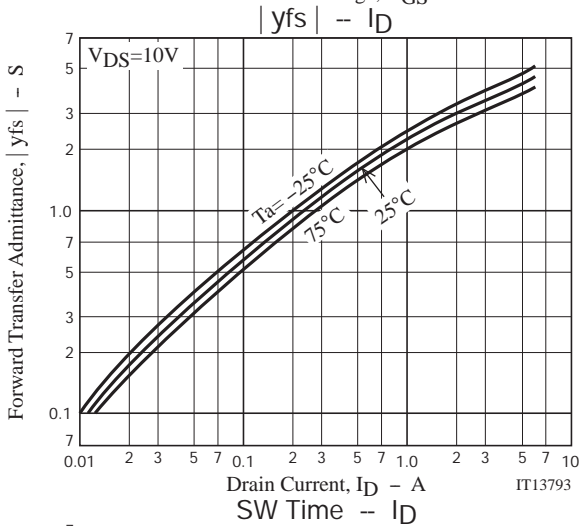
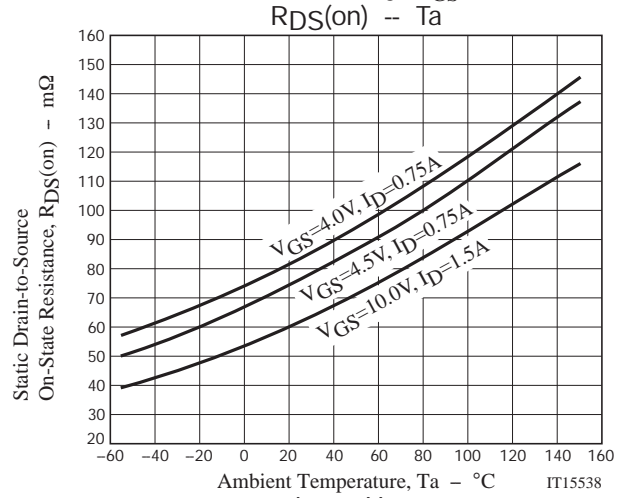
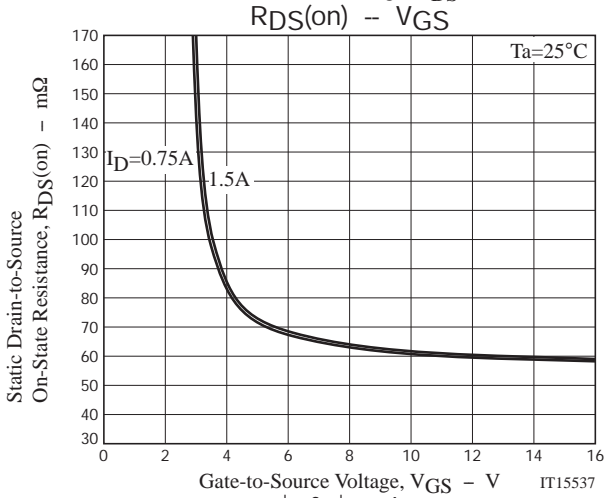
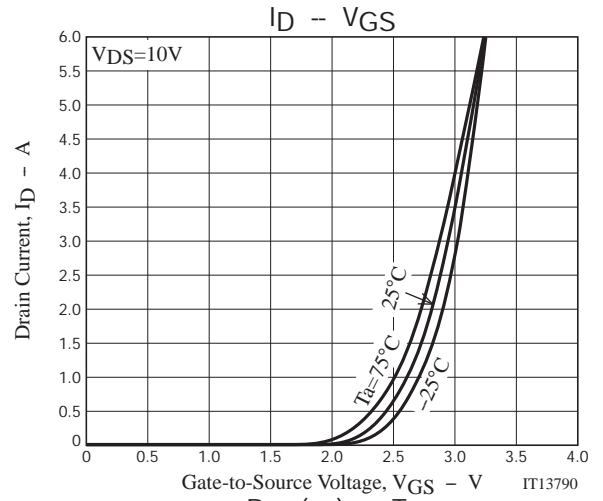
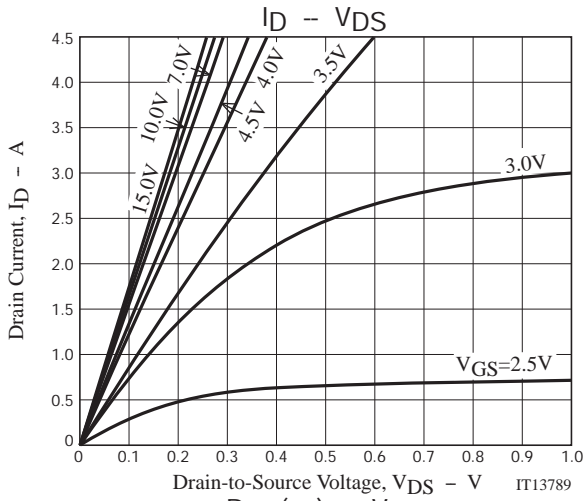
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=1mA, V_{GS}=0V$	60			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS}=60V, V_{GS}=0V$			1	μA
Gate-to-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 16V, V_{DS}=0V$			± 10	μA
Cutoff Voltage	$V_{GS(off)}$	$V_{DS}=10V, I_D=1mA$	1.2		2.6	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS}=10V, I_D=1.5A$		2.6		S
Static Drain-to-Source On-State Resistance	$R_{DS(on)1}$	$I_D=1.5A, V_{GS}=10V$		62	80	$m\Omega$
	$R_{DS(on)2}$	$I_D=0.75A, V_{GS}=4.5V$		76	106	$m\Omega$
	$R_{DS(on)3}$	$I_D=0.75A, V_{GS}=4V$		83	116	$m\Omega$
Input Capacitance	C_{iss}	$V_{DS}=20V, f=1MHz$		505		pF
Output Capacitance	C_{oss}			57		pF
Reverse Transfer Capacitance	C_{rss}			37		pF
Turn-ON Delay Time	$t_d(on)$			7.3		ns
Rise Time	t_r	See specified Test Circuit.		7.5		ns
Turn-OFF Delay Time	$t_d(off)$			41		ns
Fall Time	t_f			22		ns
Total Gate Charge	Q_g	$V_{DS}=30V, V_{GS}=10V, I_D=3A$		10		nC
Gate-to-Source Charge	Q_{gs}			1.6		nC
Gate-to-Drain "Miller" Charge	Q_{gd}			2.1		nC
Diode Forward Voltage	V_{SD}		$I_S=3A, V_{GS}=0V$		0.81	1.2

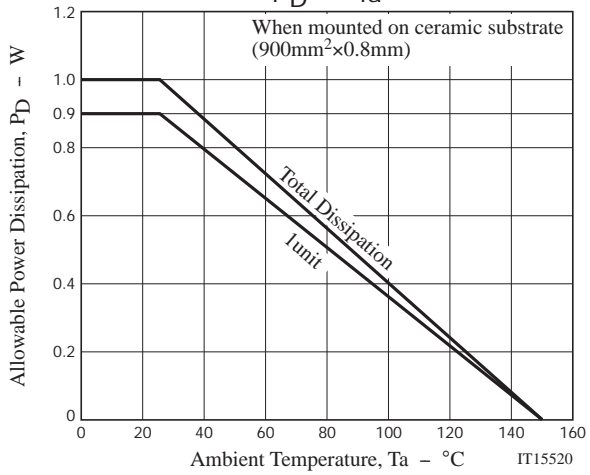
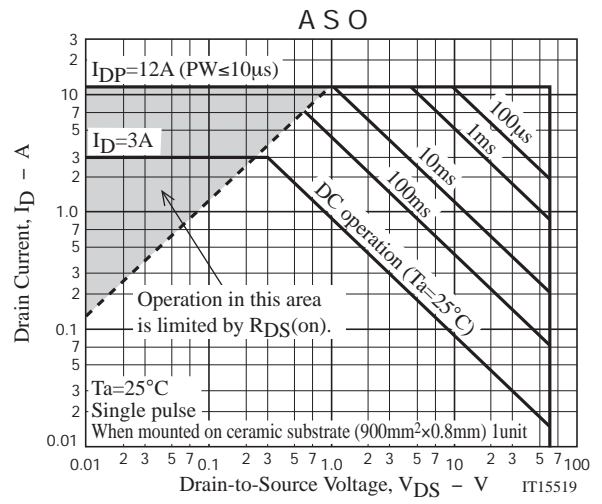
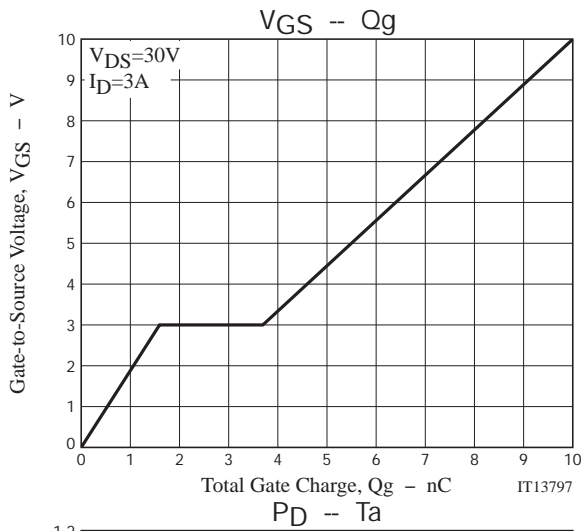
Switching Time Test Circuit



Ordering Information

Device	Package	Shipping	memo
VEC2415-TL-E	VEC8	3,000pcs./reel	Pb Free





Taping Specification

VEC2415-TL-E

1. Packing Format

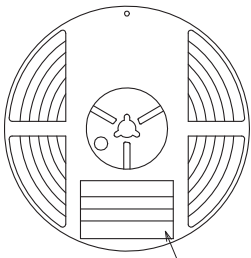
Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
VEC8	CPH6	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Reel label, Inner box label
(unit:mm)

Outer box label

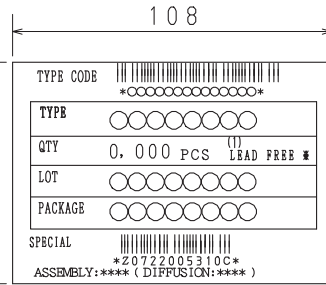
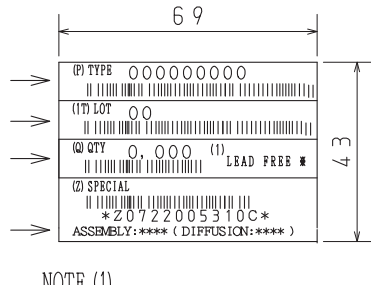
It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.

Packing method



Reel label

Type No.
LOT No.
Quantity
Origin



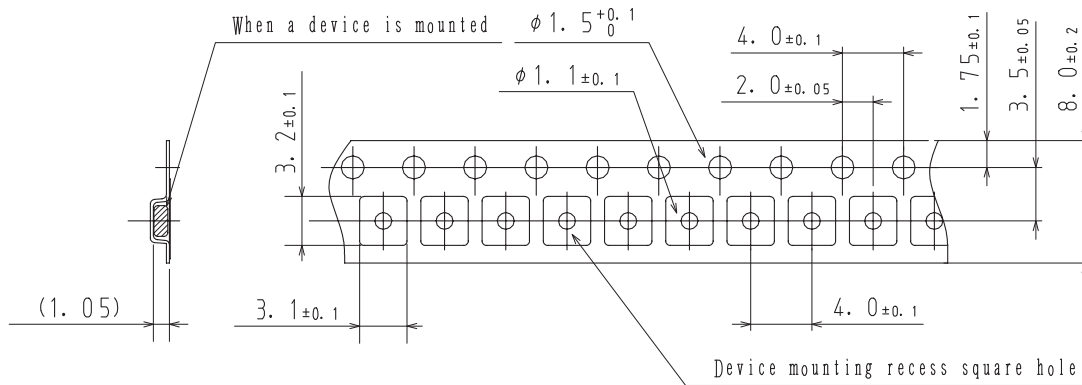
NOTE (1)

The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

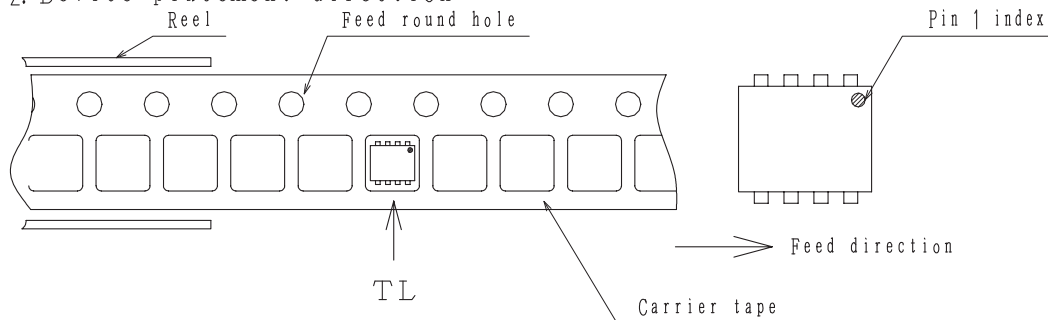
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



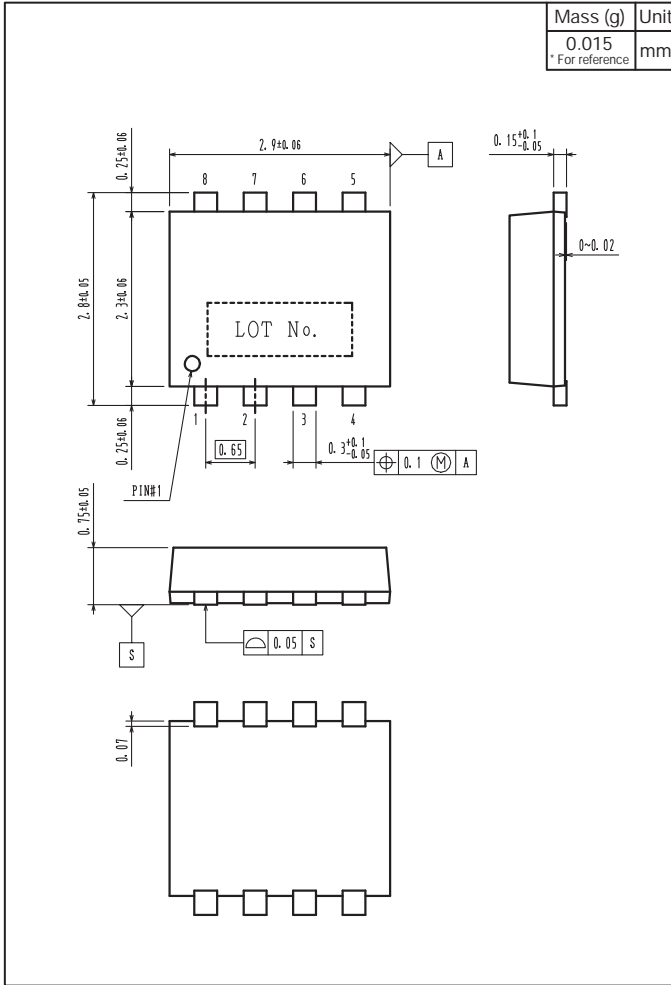
2-2. Device placement direction



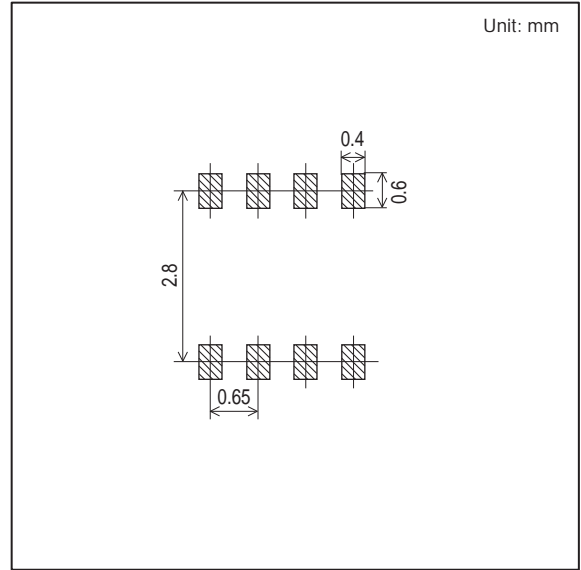
Those with oen electrode terminal on the feed hole side.....TL

VEC2415

Outline Drawing VEC2415-TL-E



Land Pattern Example



Note on usage : Since the VEC2415 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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